TOSHIBA Photocoupler IRED+Photo-IC

# **TLP759**

**Digital Logic Ground Isolation** Line Receiver Microprocessor System Interfaces Switching Power Supply Feedback Control Industrial Inverter

The TOSHIBA TLP759 consists of a high-output infrared emitting diode and a high speed detector of one chip photo diode-transistor. This unit is 8-lead DIP.

TLP759 has no internal base connection, and a Faraday shield integrated on the photodetector chip provides an effective common mode noise transient immunity.

So this is suitable for application in noisy environmental condition

- Isolation voltage: 5000 Vrms (min)
- Switching speed:  $t_{pHL} = 0.2 \mu s$  (typ.)

$$t_{pLH} = 0.3 \mu s$$
 (typ.) (R<sub>L</sub>=1.9 kΩ)

- TTL compatible
- UL-recognized: UL 1577, File No. E67349
- cUL-recognized: CSA Component Acceptance Service No.5A File No.E67349
- VDE-approved: EN 60747-5-5 (Note 1)

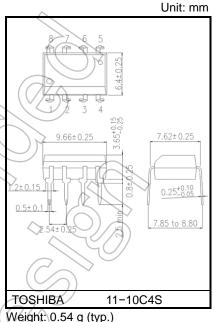
Note 1: When a VDE approved type is needed, please designate the Option (D4).

Mechanical Parameters

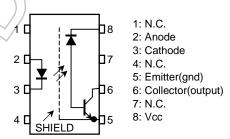
Creepage distance: 7.0 mm (min)

Clearance: 7.0 mm (min)

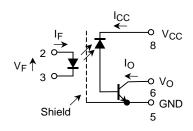
Insulation thickness: 0.4 mm (min)



#### Pin Configuration (top view)



#### **Schematic**



Start of commercial production 1993-01

#### **Absolute Maximum Ratings (Ta = 25°C)**

	Characteristic		Symbol	Rating	Unit
LED	Forward current		lF	25	mA
	Forward current derating (Ta ≥70°C)		IF / Ta	-0.8	mA / °C
	Pulse forward current	(Note 1)	lFP	50	mA
	Peak transient forward current	(Note 2)	IFPT	1	Α
	Reverse voltage		V <sub>R</sub>	(5)	V
	Diode power dissipation	(Note 3)	PD	45	mW
Detector	Output current		9	8	mA
	Peak output current		lop	16	mA
	Output voltage		VO (	-0.5 to 20	V
	Supply voltage	_	Vcc	-0.5 to 30	×
	Output power dissipation		Po	100	mW
	Output power dissipation derating (Ta ≥70°C)	(7)	Po/Ta	-2	mW/°C
Ope	Operating temperature range		Topr	-55 to 100	ွင
Stor	Storage temperature range		T <sub>stg</sub>	-55 to 125	<b>⊘</b> /℃
Lea	Lead solder temperature (10 s) (Note 4)		T <sub>sol</sub>	260	°C
Isola	Isolation voltage (AC, 60 s, R.H. ≤ 60 %) (Note 5)			5000	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1) 50 % duty cycle, 1 ms pulse width. Derate 1.6 mA / °C above 70 °C.

(Note 2) Pulse width ≤ 1 μs, 300 pps.

(Note 3) Derate 0.9 mW / °C above 70 °C.

(Note 4) Soldering portion of lead: Up to 2 mm from the body of the device.

(Note 5) Device considered a two terminal device: Pins 1, 2, 3 and 4 shorted together and pins 5, 6, 7 and 8 shorted together.

### **Electrical Characteristics (Ta = 25°C)**

Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
LDE	Forward voltage	VF	I <sub>F</sub> = 16 mA	_	1.65	1.85	V
	Forward voltage temperature coefficient	ΔV <sub>F</sub> / ΔTa	IF = 16 mA	_	-2	_	mV /°C
	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V	/_	-	10	μΑ
	Capacitance between terminals	Ст	V = 0 V, f = 1 MHz		45	_	pF
Detector	High level output current	IOH (1)	IF = 0 mA, VCC = VO = 5.5 V		У 3	500	nA
		IOH (2)	IF = 0 mA, V <sub>CC</sub> = 30 V, V <sub>O</sub> = 20 V	Z\_	_	5	
		Іон	I <sub>F</sub> = 0 mA, V <sub>CC</sub> = 30 V, V <sub>Q</sub> = 20 V Ta = 70 °C	<u>)</u> _	_	50	μΑ
	High level supply voltage	Іссн	IF = 0 mA, VCC = 30 V	_	0.01	1	μΑ
Coupled	Current transfer ratio	IO/IF	IF = 16 mA, VCC = 4.5 V VO = 0.4 V	20	40	1/	%
	Low level output voltage	VoL	IF = 16 mA, VCC = 4.5 V IO = 2.4 mA	-3		0.4	V
	Resistance (input-output)	Rs	R.H.≤ 60 %, V <sub>S</sub> = 500 V (Note 5)	1×10 <sup>12</sup>	1014	_	Ω
	Capacitance (input-output)	Cs	$V_S = 0 V, f = 1 MHz$ (Note 5)	1	0.8	_	pF
	Isolation voltage	BVs	AC, 60 s (Note 5)	5000	_	_	Vrms

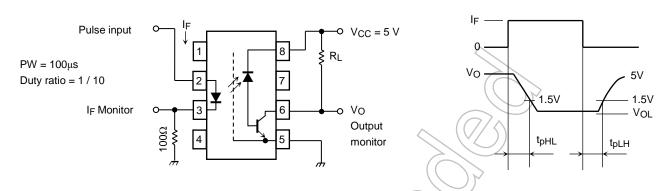
## Switching Characteristics (Ta = 25°C, VCC = 5V)

Characteristic	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Propagation delay time $(H \rightarrow L)$	tpHL		$I_F = 0 \rightarrow 16 \text{ mA},$ $R_L = 1.9 \text{ k}\Omega$	_	0.2	8.0	μS
Propagation delay time $(L \rightarrow H)$	tpLH		I <sub>F</sub> = 16 $\rightarrow$ 0 mA, RL = 1.9 kΩ	_	0.3	8.0	μS
Common mode transient immunity at logic high output (Note )	CMH	2	$I_F = 0$ mA, $V_{CM} = 400 V_{p-p}$ RL = 4.1 k $\Omega$	5000	10000	_	V / μs
Common mode transient immunity at logic low output (Note 1)	CML		IF = 16 mA, V <sub>CM</sub> = 400 V <sub>p-p</sub> R <sub>L</sub> = 4.1 kΩ	-5000	-10000	_	V / μs

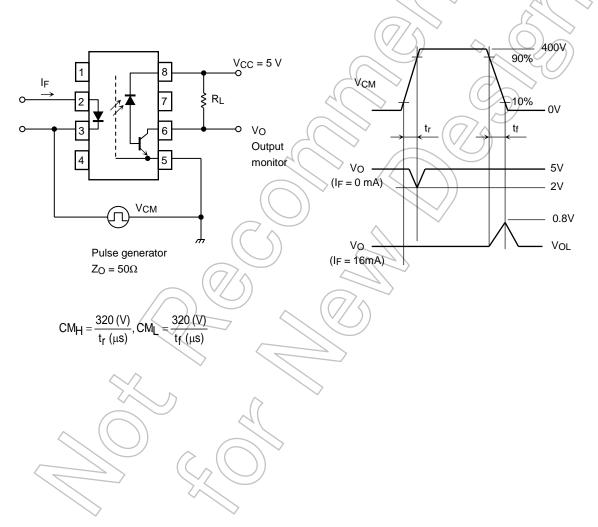
(Note 1) CML is the maximum rate of fall of the common mode voltage that can be sustained with the output voltage in the logic low state (VO < 0.8 V).

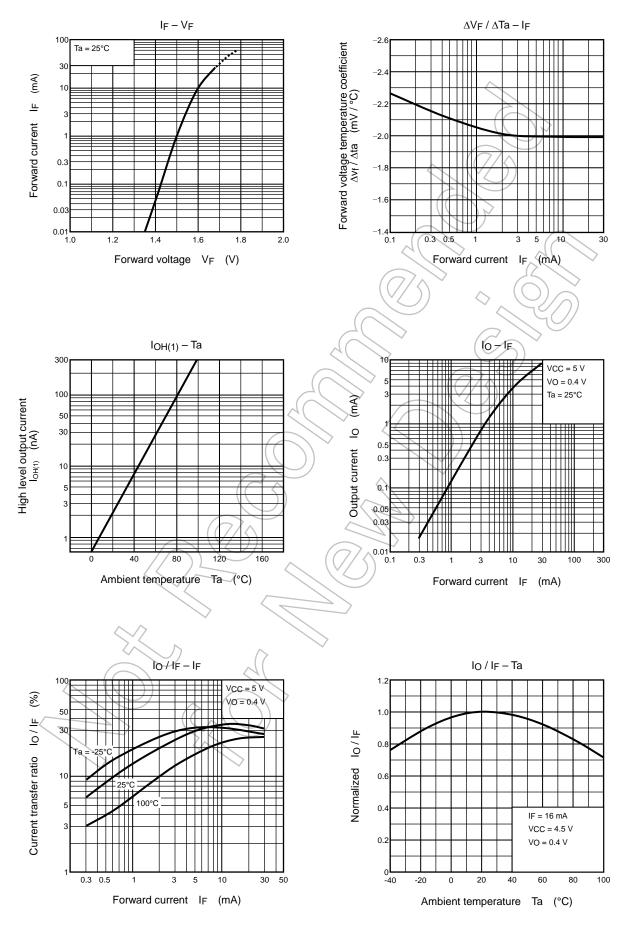
CMH is the maximum rate of rise of the common mode voltage that can be sustained with the output voltage in the logic high state ( $V_0 > 2.0 \text{ V}$ ).

## **Test Circuit 1: Switching Time Test Circuit**

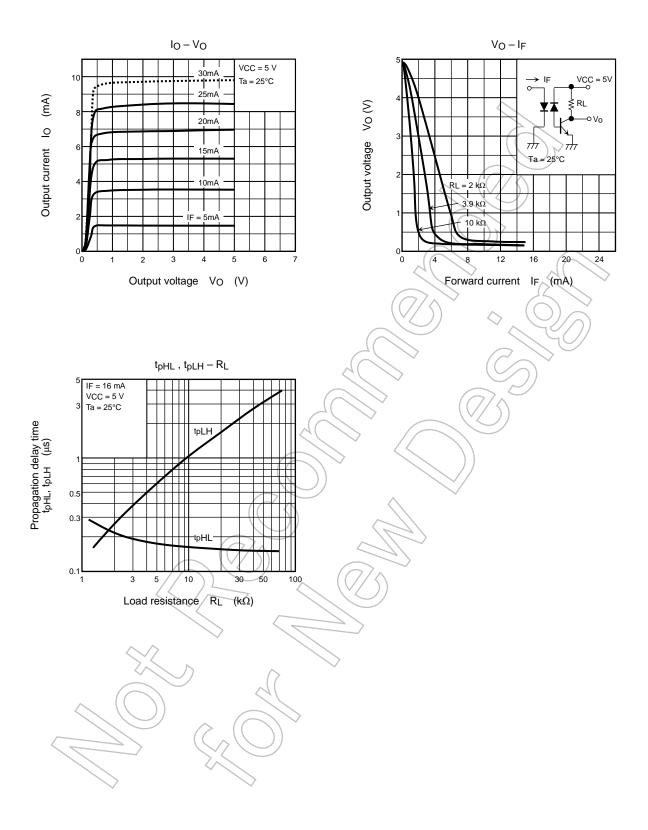








NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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